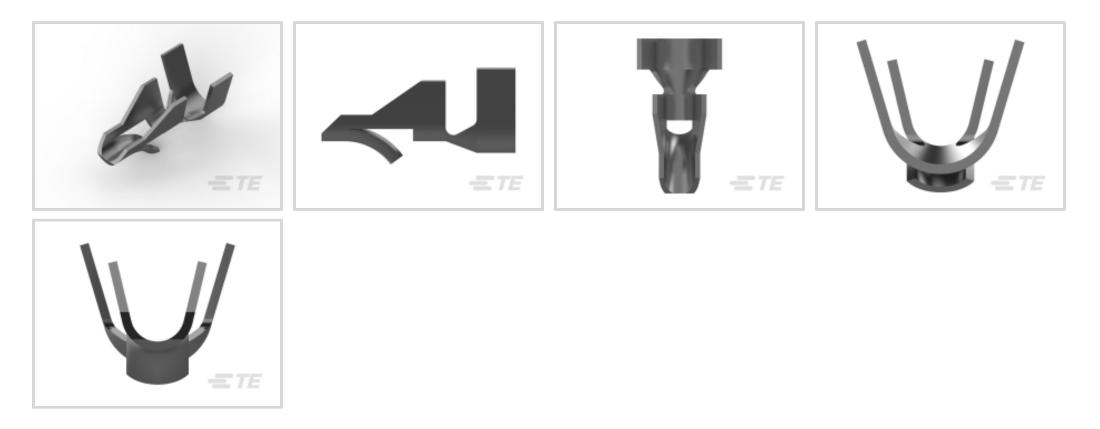
350566-7 - ACTIVE

AMP-IN

TE Internal #: 350566-7 PCB Terminals, PCB Pin, PCB Hole Diameter 1.83 mm [.072 in], 22 – 18 AWG Wire Size, .3 – .9 mm² Wire Size, Through Hole - Solder, Tin Plating, Nickel

View on TE.com >

Terminals & Splices > PCB Terminals



PCB Terminal Type: PCB Pin
PCB Thickness (Recommended): 1.57 mm [.062 in]
PCB Hole Diameter: 1.83 mm [.072 in]
Compatible Insulation Diameter (Max): 2.79 mm [.11 in]
Compatible Insulation Diameter Range: 1.52 – 2.79 mm [.06 – .11 in]

Features



Product Type Features

Terminal Features	Stud Hole	
Wire Insulation Support Retention Type	Insulation Support	
Contact Features		
Contact Underplating Material Thickness	1.01 μm[40 μin]	
Contact Mating Area Plating Material Thickness	3.04 μm[120 μin]	
PCB Terminal Type	PCB Pin	
Terminal Plating Material	Tin	
Contact Underplating Material	Nickel	
Terminal Size	Miniature	
Terminal Orientation	Straight	
Termination Features		
Termination Method to Printed Circuit Board	Through Hole - Solder	
Product Terminates To	Printed Circuit Board	
Mechanical Attachment		

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Wire Insulation Support	With
Dimensions	
Extension Below Board	3.43 mm[.135 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
PCB Hole Diameter	1.83 mm[.072 in]
Compatible Insulation Diameter (Max)	2.79 mm[.11 in]
Compatible Insulation Diameter Range	1.52 – 2.79 mm[.06 – .11 in]
Wire Size	.3 – .9 mm²
Jsage Conditions	
Insulation Option	Uninsulated
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Packaging Features	
Packaging Quantity	7000
Packaging Method	Package
Other	
Terminals & Splices Comment	.2 brass material.

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC	
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free	

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent

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chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



	062F110F



Customers Also Bought

		REAL TE	NEW DISCHARGE AND ADDRESS OF THE OWNER AND ADDRESS OF THE OWNER ADDRESS
	=TE		= TE
TE Part #6609987-2 15SRB1-R=F8219A	TE Part #T2030001015-000 CEM-1.5	TE Part #3-644893-4 04P CST100 SHRD HDR ASSY LF	TE Part #T2030002002-000 CEF-0.3

PCB Terminals, PCB Pin, PCB Hole Diameter 1.83 mm [.072 in], 22 – 18 AWG Wire Size, .3 – .9 mm² Wire Size, Through Hole - Solder, Tin Plating, Nickel







Documents

Product Drawings MINI AMP-IN 22-18 AWG POST TIN PLTD

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_350566-7_AT.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_350566-7_AT.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_350566-7_AT.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Product Environmental Compliance MD_350566-7_02232016651_dmtec

English

MD_350566-7_02232016651_dmtec

English

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